

Bandpass Filter

SXBP-820+

50Ω 769 to 872 MHz

Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	0.5W Max.

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

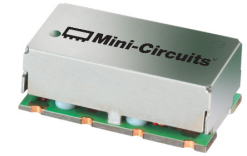
INPUT	1
OUTPUT	8
GROUND	2, 3, 4, 5, 6, 7

Features

- High Rejection
- Flat Group Delay
- Shielded case
- Aqueous washable

Applications

- Mobile TV
- Receivers / Transmitters
- Harmonic rejection

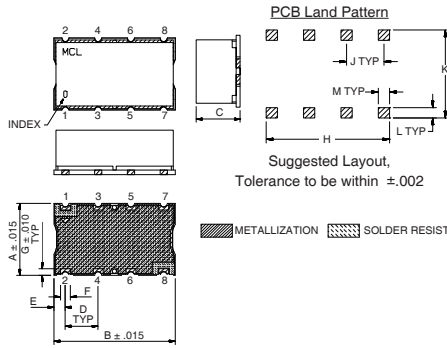


Generic photo used for illustration purposes only
CASE STYLE: HF1139

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Outline Drawing

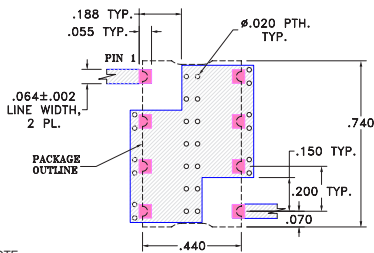


Outline Dimensions (inch/mm)

A	B	C	D	E	F	
.440	.740	.27	.200	.07	.060	
11.18	18.80	6.86	5.08	1.78	1.52	
G	H	J	K	L	M	wt.
.040	.660	.200	.470	.055	.060	grams
1.02	16.76	5.08	11.94	1.40	1.52	3.0

Note: Please refer to case style drawing for details

Demo Board MCL P/N: TB-368
Suggested PCB Layout (PL-230)



NOTE:

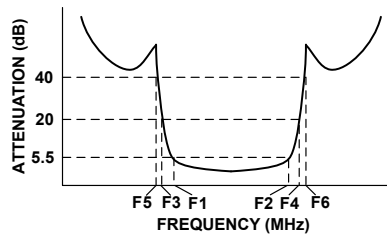
1. TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS .025" ± .002". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

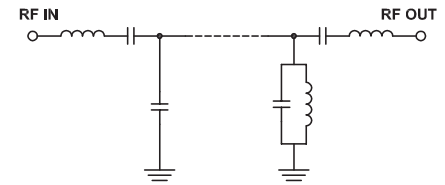
Bandpass Filter Electrical Specifications (T_{AMB} = 25°C)

CENTER FREQ. (MHz)	PASSBAND (MHz) (Loss < 5.5dB)	STOPBANDS (MHz)				VSWR (:1)		
		Loss > 20dB		Loss > 40dB		Passband		Stopband
F _c	F ₁ - F ₂	F ₃	F ₄	F ₅	F ₆	Typ.	Max.	Typ.
820	769 - 872	550	920	450	1000 - 2600	1.7	2.3	20

Typical Frequency Response

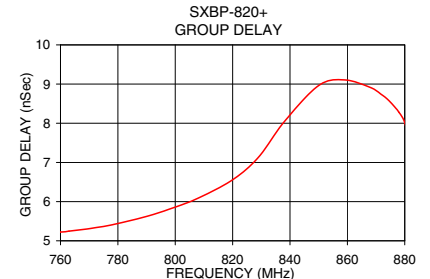
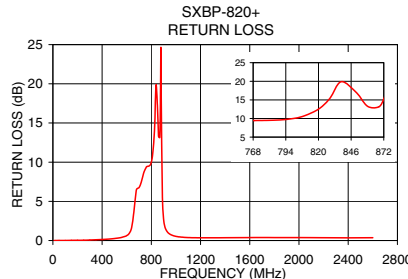
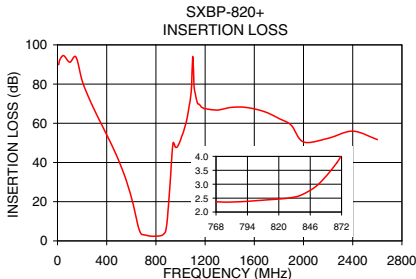


Functional Schematic



Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)		Return Loss (dB)	Frequency (MHz)	Group Delay (nSec)
	\bar{x}	σ			
10	89.91	3.72	0.01	760	5.22
100	91.17	3.09	0.01	766	5.27
450	47.71	0.32	0.18	769	5.30
550	32.51	0.37	0.46	772	5.33
619	17.67	0.77	0.88	778	5.41
640	11.85	0.92	1.63	790	5.62
658	6.91	0.76	3.61	799	5.83
769	2.37	0.19	9.46	808	6.09
799	2.40	0.13	9.95	820	6.56
820	2.47	0.11	12.51	829	7.13
850	2.90	0.28	17.04	838	8.04
872	4.05	0.30	15.27	850	8.96
880	5.13	0.54	19.23	859	9.11
890	9.27	1.73	5.58	868	8.91
900	16.48	2.56	2.71	872	8.73
920	33.32	3.78	1.36	874	8.61
1000	51.37	0.64	0.53	876	8.46
2600	51.67	0.63	0.36	880	8.01



Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuit's standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp



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MODEL: SXBP-820+:			
NAME (PRINT)	SIGNATURE	DATE	FILE SIZE
GALINA DUBONIN	<i>Gd.</i>	09 Feb', 2009	170 KB
URJITA ENGINEER	<i>Urjita Lee</i>	10 Feb', 2009	
DAVID HAIMOVICH	<i>DH</i>	09 Feb', 2009	
APPROVED BY:	HK	13 Feb', 2009	

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Surface Mount Band Pass Filter

SXBP-820+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)	FREQUENCY (MHz)	GROUP DELAY (nsec)
10	89.91	0.01	760	5.22
100	91.17	0.01	766	5.27
450	47.71	0.18	769	5.30
550	32.51	0.37	772	5.33
619	17.67	0.88	778	5.41
640	11.85	1.63	790	5.62
658	6.91	3.61	799	5.83
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850	2.90	17.04	838	8.04
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920	33.32	1.36	874	8.61
1000	51.37	0.53	876	8.46
2600	51.67	0.36	880	8.01

REV. X1
SXBP-820+
080223
Page 1 of 1



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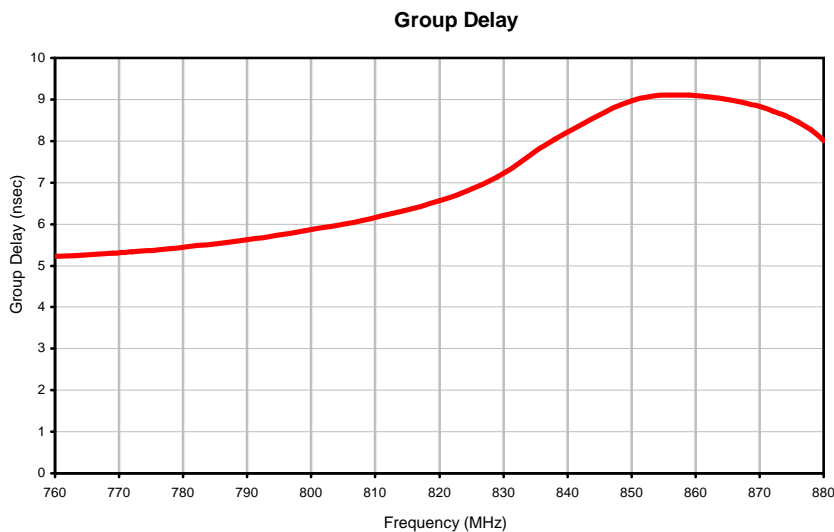
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Surface Mount Band Pass Filter

SXBP-820+

Typical Performance Curves



REV. X1
SXBP-820+
080223
Page 1 of 1



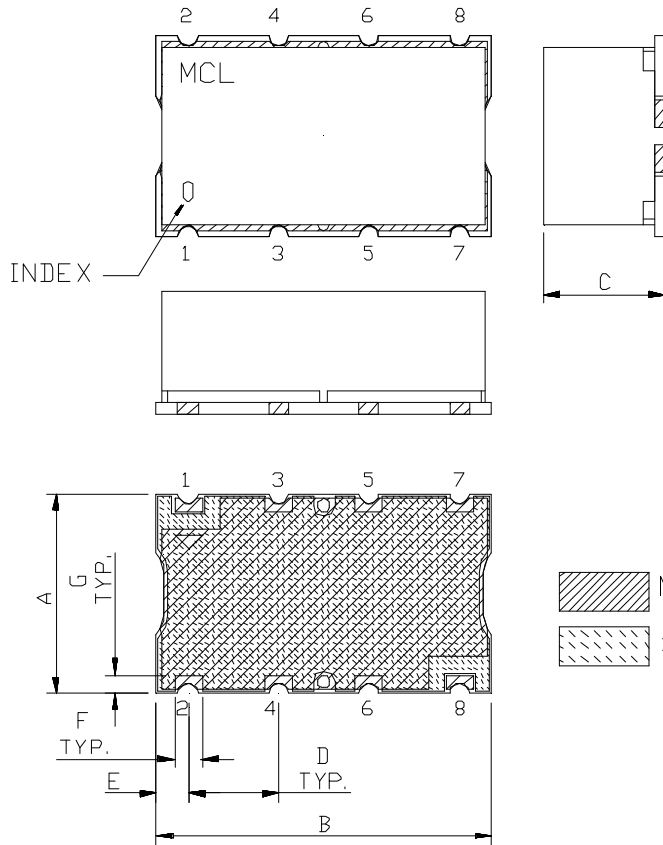
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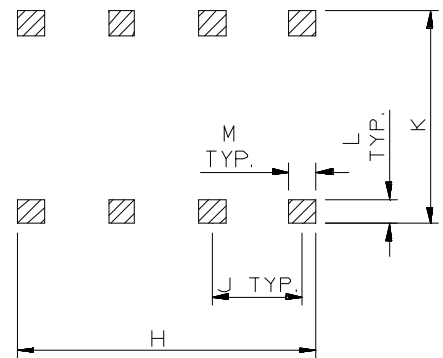
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Outline Dimensions



PCB Land Pattern



 METALLIZATION
 SOLDER RESIST

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HF1139	.44 (11.18)	.74 (18.80)	.27 (6.86)	.200 (5.08)	.07 (1.78)	.060 (1.52)	.040 (1.02)	.660 (16.76)	.200 (5.08)	.470 (11.94)	.055 (1.40)	.060 (1.52)	3.0

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm 0.015''$; 3 Pl. $\pm 0.01''$

Notes:

- Case material: Nickel-Silver alloy.
- Base: Printed wiring laminate.
- Termination finish:
 - For RoHS Case Styles: 2-5 μ inch (.05-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate.
 - For RoHS-5 Case Styles: Tin-Lead plate.



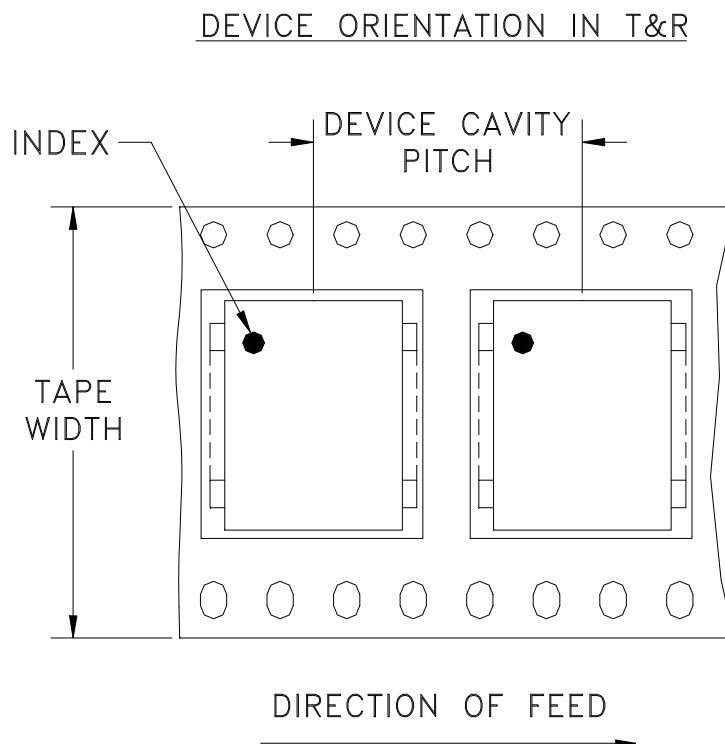
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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F5



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	16	13	500

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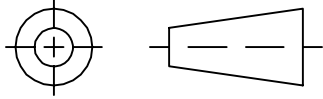
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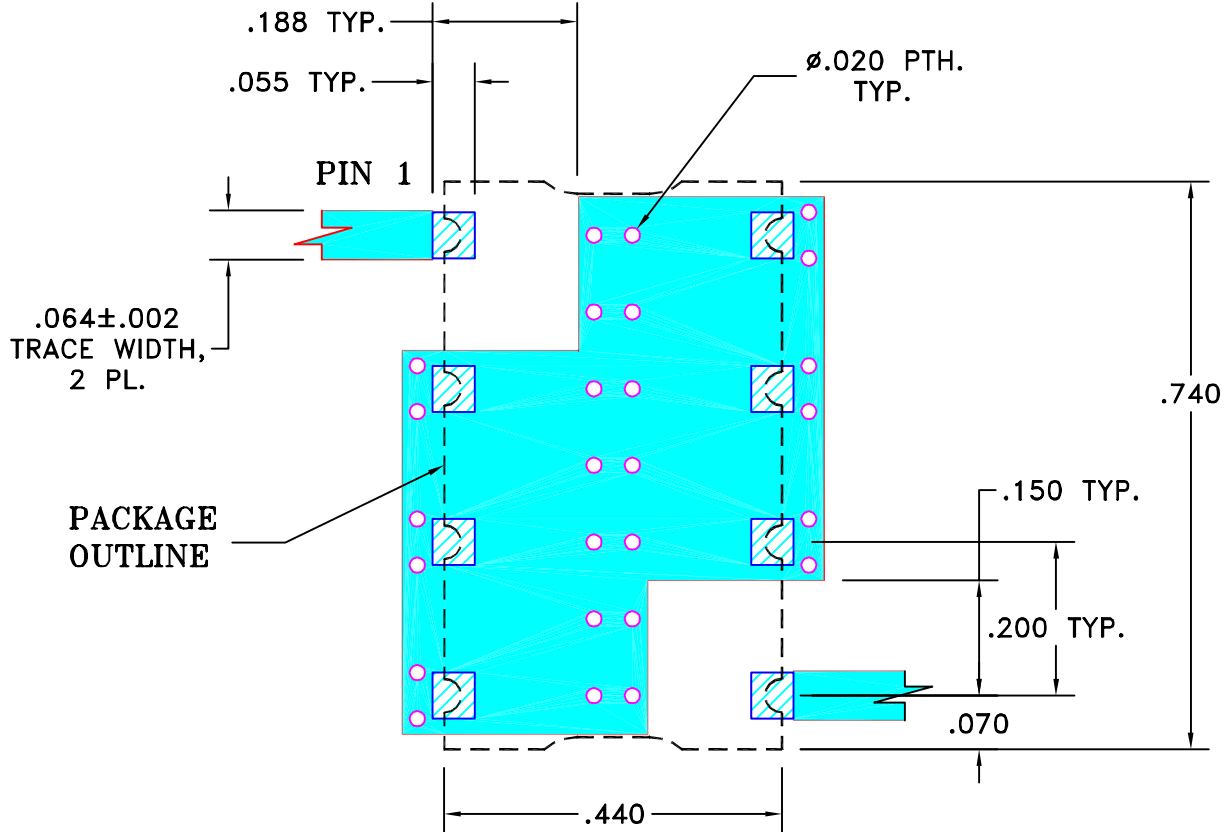
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M101757	NEW RELEASE (FROM RAVON)	11/05	DK	HH
OR	R62293	NEW RELEASE (FROM RAVON)	11/05	DK	HH

**SUGGESTED MOUNTING CONFIGURATION
FOR HF1139 CASE STYLE, cr PIN CONNECTION, 50 OHM.**



NOTE:

- TRACE WIDTH IS SHOWN FOR FR4 WITH DIELECTRIC THICKNESS: .025"±.002". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	DK (RAVON)	29 NOV 05
	CHECKED	RZ (RAVON)	29 NOV 05
	APPROVED	HH (RAVON)	29 NOV 05



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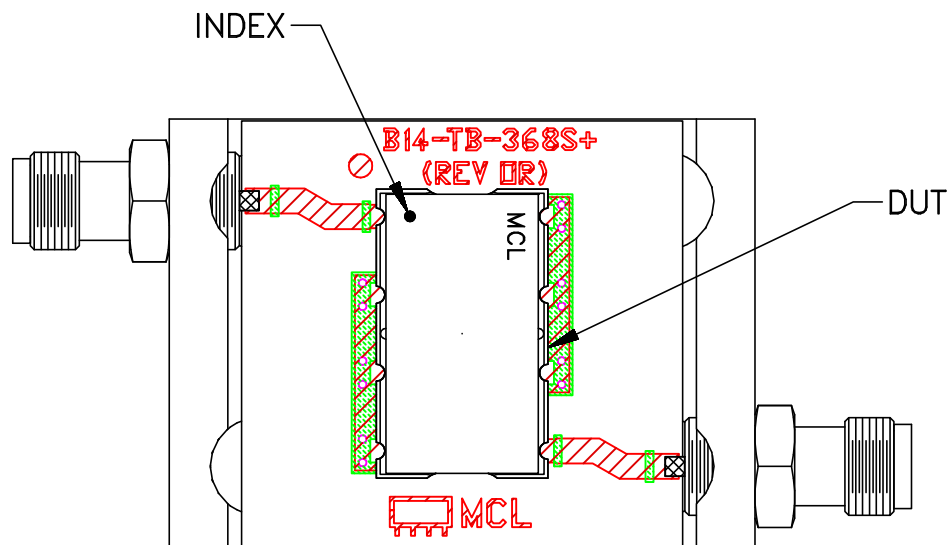
13 Neptune Avenue
Brooklyn NY 11235

PL, cr, HF1139, SCLF, TB-368

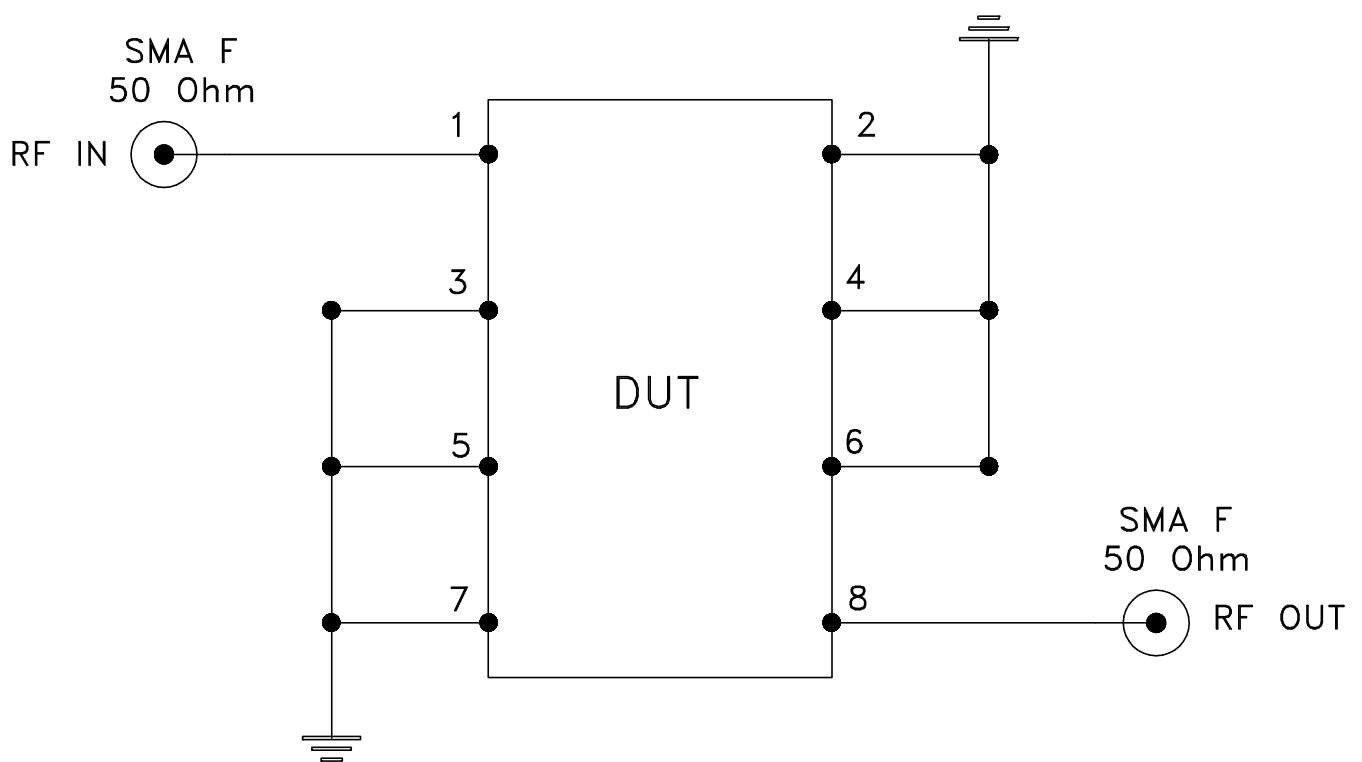
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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-230	REV: OR
FILE: 98PL230	SCALE: 4:1	SHEET: 1 OF 1	

Evaluation Board and Circuit




TB-368



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS R04350B or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215